

Specification

Client Name: _____

Client P/N: _____

Factory P/N: OF-SMD2012G-1

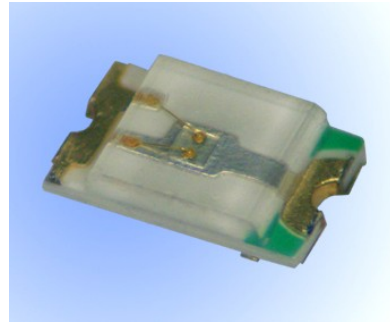
Sending Date: _____

Features

- Extremely wide viewing angle
- Suitable for all SMT assembly and solder process
- Available on tape and reel
- Moisture sensitivity level: Level 3
- Package: 3000 pcs/reel
- RoHS compliant

Description

The Green source color devices are made with InGaN on Substrate Light Emitting Diode



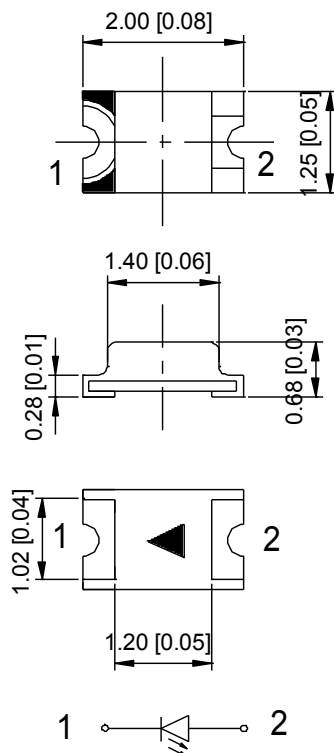
Applications

- Optical indicator
- Indoor display
- Backlighting in dashboard and switch
- Flat backlighting for LCD, symbol and display
- General use

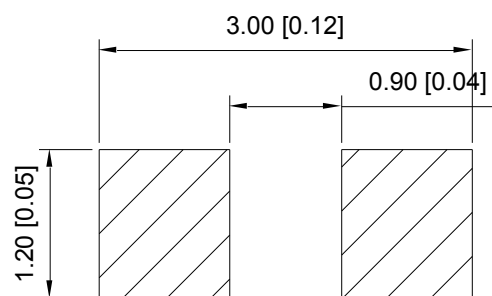


ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Package Dimensions



Recommended Soldering Pattern



Notes:

1. All dimension units are millimeters.
2. All dimension tolerance is ± 0.15 mm unless otherwise noted.

Selection Guide

Part No.	Dice	Lens Type	Luminous intensity(mcd) @ 20mA		Viewing Angle
			Min.	Typ.	2θ1/2
OF-SMD2012G-1	Green (InGaN)	Water Clear	600	800	120°

Note:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. the above luminous intensity measurement allowance tolerance ±10%.

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Typ.	Max	Units	Test Conditions
Forward Voltage	V _F	2.8	--	3.4	V	I _F =20mA
Reverse Current	I _R	--	--	10	uA	V _R = 5V
Dominate Wavelength	λ _d	515	--	525	nm	I _F =20mA

Absolute Maximum Ratings at Ta=25°C

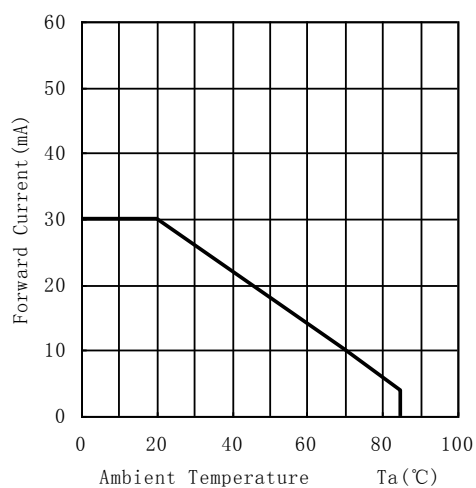
Parameter	Symbol	Rating	Units
Power Dissipation	P _d	105	mW
DC Forward Current	I _F	30	mA
Peak Forward Current [1]	I _{FP}	100	mA
Reverse Voltage	V _R	5	V
Electrostatic Discharge (HBM)	ESD	1000	V
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +100	°C

Note:

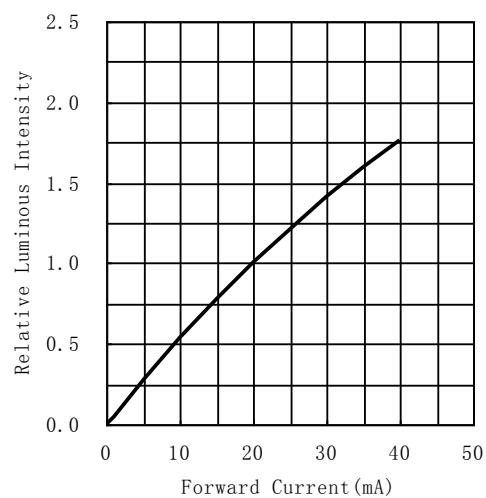
1. 1/10 Duty cycle, 0.1ms pulse width.
2. The above forward voltage measurement allowance tolerance ±0.1V.

Typical optical characteristics curves

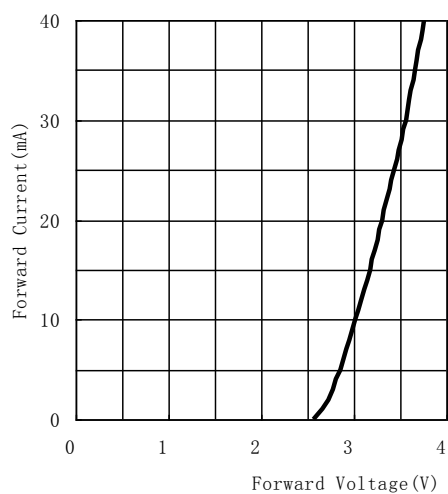
Ambient Temperature VS. Forward Current



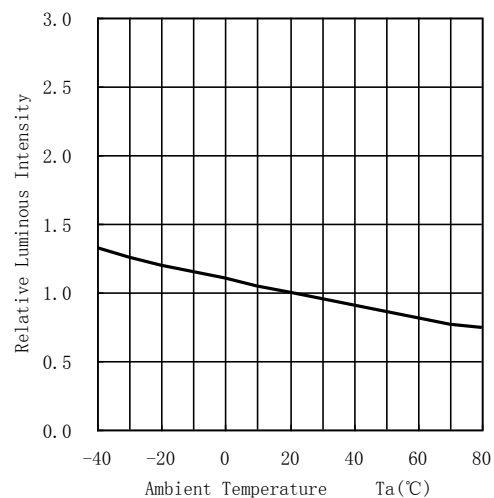
Forward Current VS. Relative Intensity



Forward Voltage VS. Forward Current



Ambient Temperature VS. Relative Intensity



Relative spectral emission

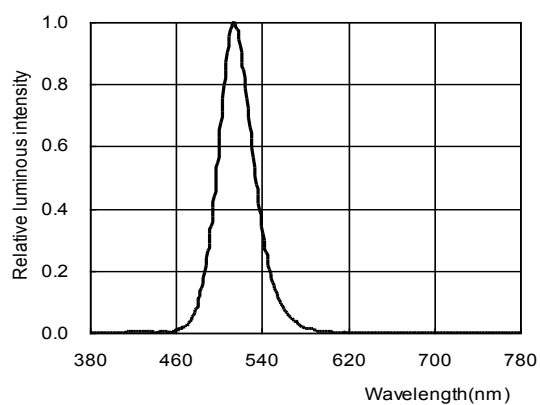
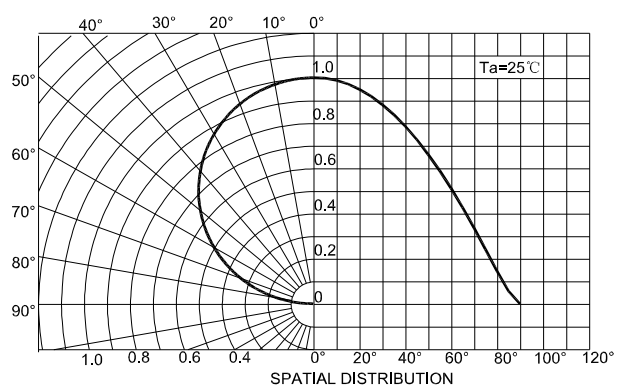


Diagram characteristics of radiation



Reliability Test Items And Conditions

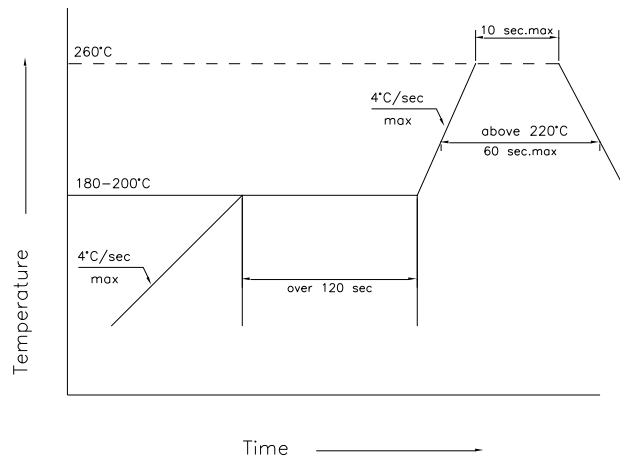
The reliability of products shall be satisfied with items listed below.
Confidence level :90%
LTPD :10%

No.	Items	Ref. Standard	Test Condition	Test Hours/ Cycles	Sample Size	Ac/Re
1	Reflow	JESD22-B106	Temp:260℃max T=10 sec	3 times.	22Pcs.	0/1
2	Temperature Cycle	JESD22-A104	100℃±5℃ 30 min. ↑↓5 min -40℃±5℃ 30 min.	100 Cycles	22Pcs.	0/1
3	Thermal Shock	JESD22-A106	100℃±5℃ 5 min. ↑↓ -40℃±5℃ 5 min.	100 Cycles	22Pcs.	0/1
4	High Temperature Storage	JESD22-A103	Temp:100℃±5℃	1000Hrs.	22Pcs.	0/1
5	Low Temperature Storage	JESD22-A119	Temp:-40℃±5℃	1000Hrs.	22Pcs.	0/1
6	DC Operating Life	JESD22-A108	Ta=25℃±5℃ IF=20mA	1000Hrs.	22Pcs.	0/1
7	High Temperature High Humidity	JESD22-A101	85℃±5℃/ 85%RH IF=5mA	1000Hrs.	22Pcs.	0/1

*The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.

SMT Reflow Soldering Instructions

1. Reflow soldering should not be done more than two times
2. When soldering, do not put stress on the LEDs during heating

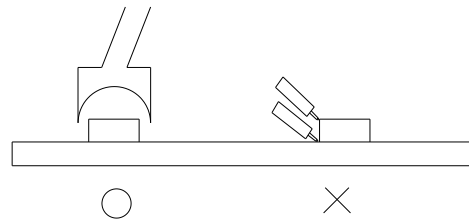


Soldering iron

1. When hand soldering, the temperature of the iron must be less than 300°C for 3 seconds
2. The hand solder should be done only one time

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.



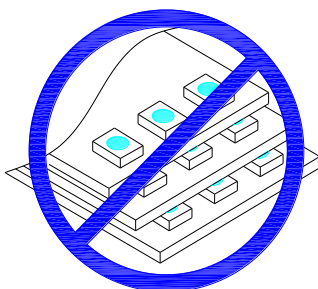
Cautions

The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will influence the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when use the picking up nozzle, the pressure on the silicone resin should be proper.

Handling Precautions

1. Do not stack together assembled PCBs containing LEDs. Impact may scratch the silicone lens or damage

2. Not available in the situation of acidity for PH



Label

IV: Luminous intensity rank
λD: Dominate Wavelength
VF: Forward voltage rank

RoHS

Part No: XXXXXXXXXXXXXXXXXXXX

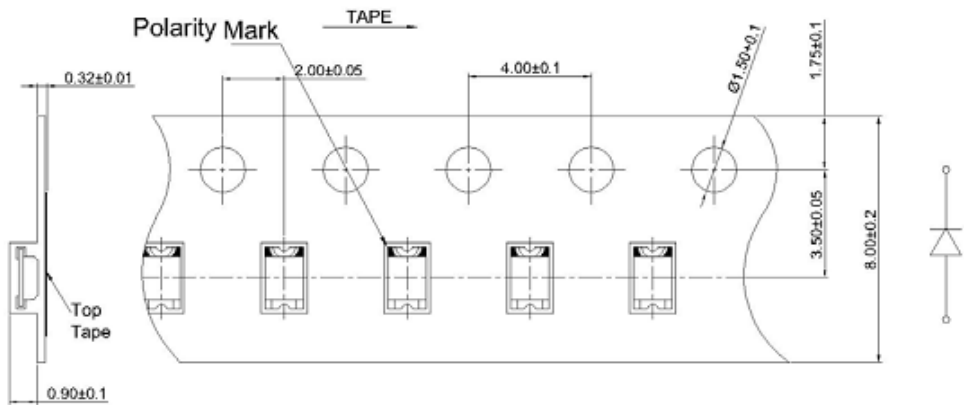
IV: VF: WD:

Quantity:

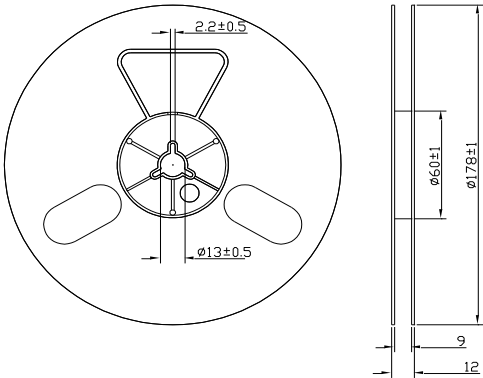
Sealing date: XXXXXXXXXXXXXXXXXXXX



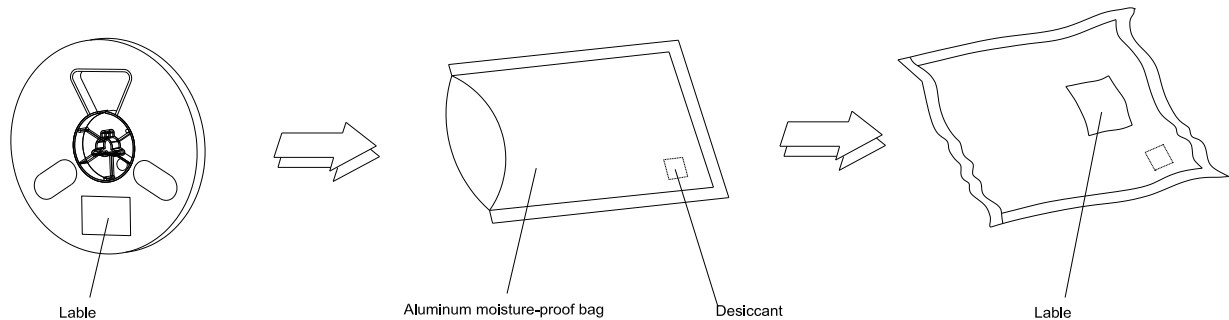
Tape Specifications (Units : mm)



Reel Dimensions



Moisture Resistant Packaging



Note: The tolerances unless mentioned is ±0.1mm , Unit: mm